

Patterning high resolution features through the integration of an advanced lithography system with a novel nozzle-less spray coating technology

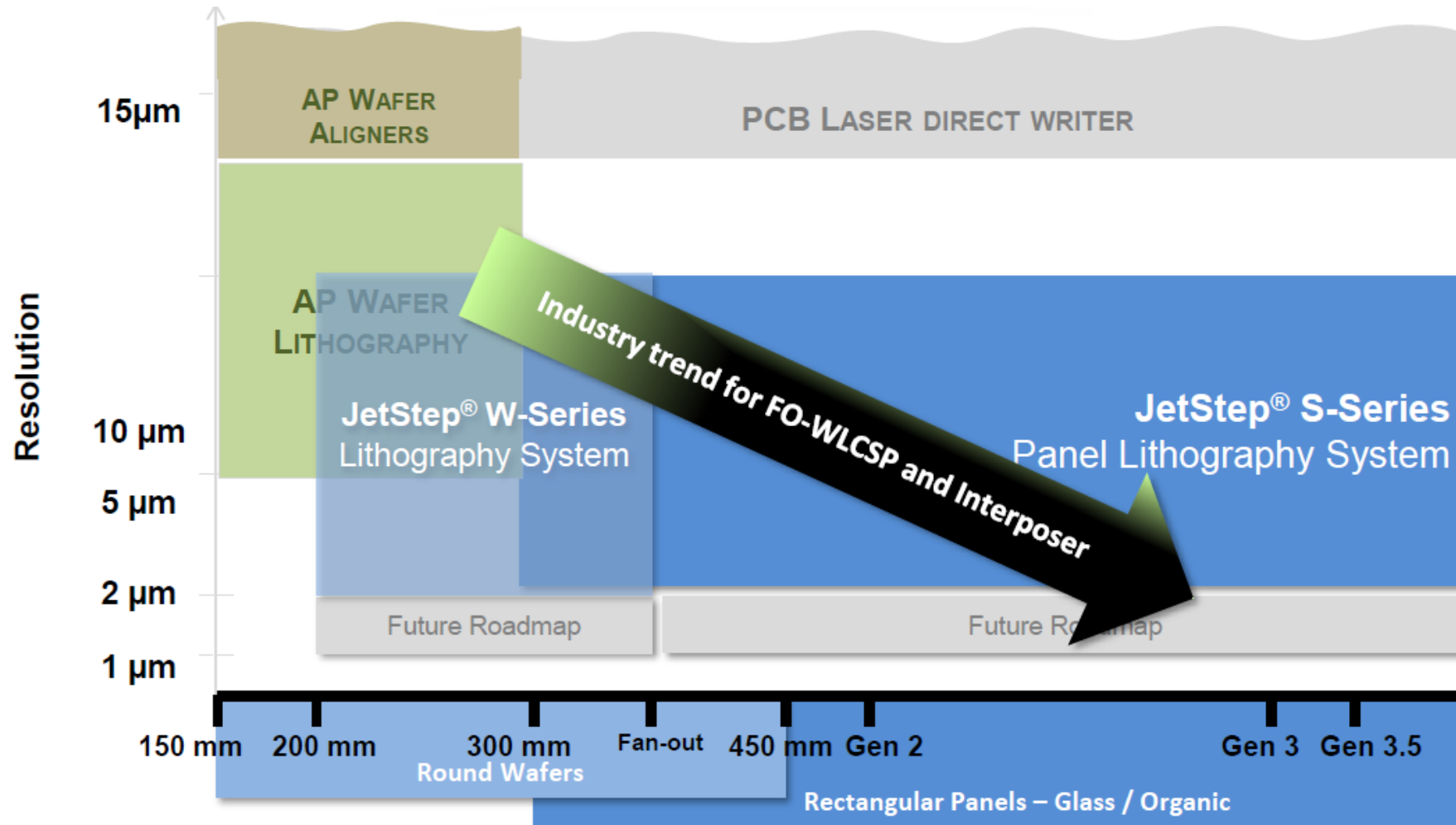
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 - Spray coating process
 - Lithography
- Results
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 - Cost reduction
- Conclusion & Acknowledgments



Trend is finer resolution and larger substrate size